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Self Protected High Side Driver with Temperature Shutdown and Current Limit

NCV8452

The NCV8452 is a fully protected High–Side driver that can be used to switch a wide variety of loads, such as bulbs, solenoids and other activators. The device is internally protected from an overload condition by an active current limit and thermal shutdown.

Features

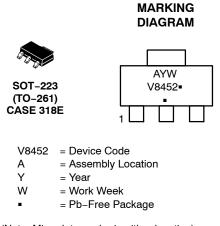
- Short Circuit Protection
- Thermal Shutdown with Automatic Restart
- CMOS (3 V/5 V) Compatible Control Input
- Overvoltage Protection and Shutdown
- Output Voltage Clamp for Inductive Switching
- Under Voltage Shutdown
- Loss of Ground Protection
- ESD Protection
- Reverse Battery Protection (with external resistor)
- Very Low Standby Current
- NCV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

Typical Applications

- Switch a Variety of Resistive, Inductive and Capacitive Loads
- Can Replace Electromechanical Relays and Discrete Circuits
- Automotive / Industrial

PRODUCT SUMMARY

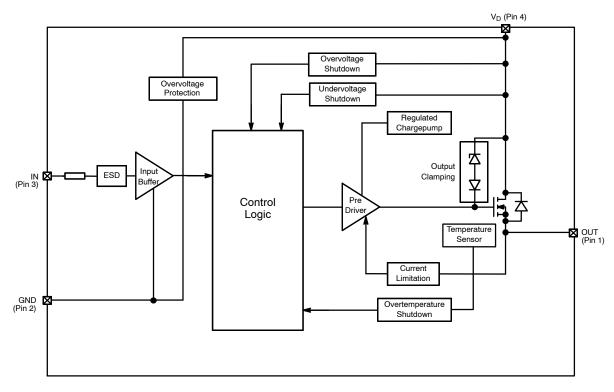
Symbol	Characteristics	Value	Unit
V _{OV}	Overvoltage Protection	41	V
V _D	Operation Voltage	5 – 34	V
R _{ON}	On-State Resistance	200	mΩ
I _{ILIM}	Output Current Limit	1.0	А



(Note: Microdot may be in either location)

ORDERING INFORMATION

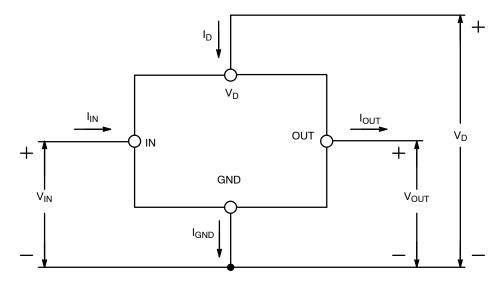
See detailed ordering and shipping information in the package dimensions section on page 12 of this data sheet.





PACKAGE PIN DESCRIPTION

Pin #	Symbol	Description
1	OUT	Output
2	GND	Ground
3	IN	Logic Level Input
4	VD	Supply Voltage







MAXIMUM RATINGS

Rating	Symbol	Value	Unit
DC Supply Voltage	V _D	40	V
Peak Transient Input Voltage (Load Dump 37.5 V, V_D = 13.5 V, ISO7637–2 pulse5) (Note 1)	V _{peak}	51	V
Input Voltage	V _{IN}	-5 to V _D	V
Input Current	I _{IN}	±5	mA
Output Current	I _{OUT}	Internally Limited	А
Power Dissipation $@T_A = 25^{\circ}C$ (Note 3) $@T_A = 25^{\circ}C$ (Note 4)	PD	1.19 1.76	W
Electrostatic Discharge (Note 1) (HBM Model 100 pF / 1500 Ω) Input Output V _D		±1 ±5 ±5	kV
Single Pulse Inductive Load Switch Off Energy (Note 1) (L = 4.55 H, V_D = 13.5 V; I _L = 0.5 A, T _{Jstart} = 25°C)	E _{AS}	0.8	J
Operating Junction Temperature	ТJ	-40 to +150	°C
Storage Temperature	T _{storage}	–55 to +150	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

Not subjected to production testing
Reverse Output current has to be limited by the load to stay within absolute maximum ratings and thermal performance.

3. Minimum pad.

4. 1 in square pad size, FR-4, 1 oz Cu.

THERMAL RESISTANCE RATINGS

Parameter	Symbol	Max Value	Unit
Thermal Resistance (Note 5) Junction-to-Soldering Point Junction-to-Ambient (Note 6) Junction-to-Ambient (Note 7)	R _{thJS} R _{thJA} R _{thJA}	10 105 71	°C/W °C/W °C/W

5. Reverse Output current has to be limited by the load to stay within absolute maximum ratings and thermal performance.

6. Minimum pad.

7. 1 in square pad size, FR-4, 1 oz Cu.

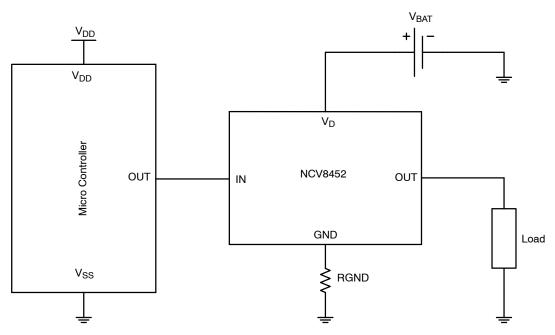


ELECTRICAL CHARACTERISTICS (V_D = 13.5 V; -40°C < T_J < 150°C unless otherwise specified)

				Value		
Rating	Symbol	Conditions	Min	Тур	Max	Unit
Operating Supply Voltage	VD		5	-	34	V
Undervoltage Shutdown	V _{UV}		2.5		5.5	V
Undervoltage Restart	V _{UV(res)}				6.0	V
Undervoltage Hysteresis	V _{UV(hyst)}			0.3		
Overvoltage Shutdown	V _{OV}		34		42	V
Overvoltage Restart	V _{OV(res)}		33			
On-state Resistance	R _{ON}	$I_{OUT} = 0.5 \text{ A}, V_{IN} = 5 \text{ V}, T_J = 25^{\circ}\text{C}$ $I_{OUT} = 0.5 \text{ A}, V_{IN} = 5 \text{ V}, T_J = 150^{\circ}\text{C}$		160 -	200 400	mΩ
Standby Current	I _{D(off)}	V _{IN} = V _{OUT} = 0 V		12	25	μA
Active Ground Current	I _{GND(on)}	V _{IN} = 5 V		1	1.8	mA
Output Leakage Current	I _{OUT(off)}	V _{IN} = 0 V			2	μΑ
INPUT CHARACTERISTICS						
Input Voltage – Low	V _{IN(low)}				0.8	V
Input Voltage – High	V _{IN(high)}		2.2			V
Off State Input Current	I _{IN(off)}	V _{IN} = 0.7 V			10	μΑ
On State Input Current	I _{IN(on)}	V _{IN} = 5.0 V			10	μΑ
Input Threshold Hysteresis	V _{IN(hyst)}			0.3		V
Input Resistance	R _l		1.5	2.8	3.5	kΩ
SWITCHING CHARACTERISTICS						
Turn-On Time	t _{on}	to 90% V _{OUT} , R _L = 24 Ω		60	120	μs
Turn-Off Time	t _{off}	to 10% V _{OUT} , R _L = 24 Ω		60	120	μs
Slew Rate On	dV _{OUT} /dt _{on}	10% to 30% V _{OUT} , R _L = 24 Ω		1	4	V/μs
Slew Rate Off	dV _{OUT} /dt _{off}	70% to 40% V _{OUT} , R _L = 24 Ω		1	4	V/μs
REVERSE BATTERY (Note 8)						
Reverse Battery	-V _D	Requires a 150 Ω Resistor in GND Connection			32	V
Forward Voltage	V _F	T _J = 150°C		0.6		V
PROTECTION FUNCTIONS (Note 9)						
Temperature Shutdown (Note 8)	TSD		150	175	200	°C
Temperature Shutdown Hysteresis (Note 8)	TSD _(hyst)			10		°C
Overvoltage Protection	V _{OV}	I _D = 4 mA	41			V
Switch Off Output Clamp Voltage	V _{CLAMP}	I _D = 4 mA, V _{IN} = 0 V	V _D - 41	V _D - 47		V
Output Current Limit Initial Peak	I _{LIM}	$V_D = 20 \text{ V}, \text{ T}_J = 25^{\circ}\text{C}$ $\text{T}_J = -40^{\circ}\text{C} \text{ to}150^{\circ}\text{C}$	1.0	1.8 -	3	А

 Not subjected to production testing
To ensure long term reliability under heavy overload or short circuit conditions, protection and related diagnostic signals must be used together with a proper hardware/software strategy. If the devices operates under abnormal conditions this hardware/software solutions must limit the duration and number of activation cycles.







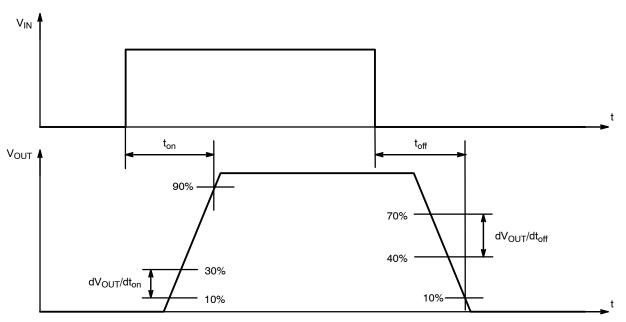
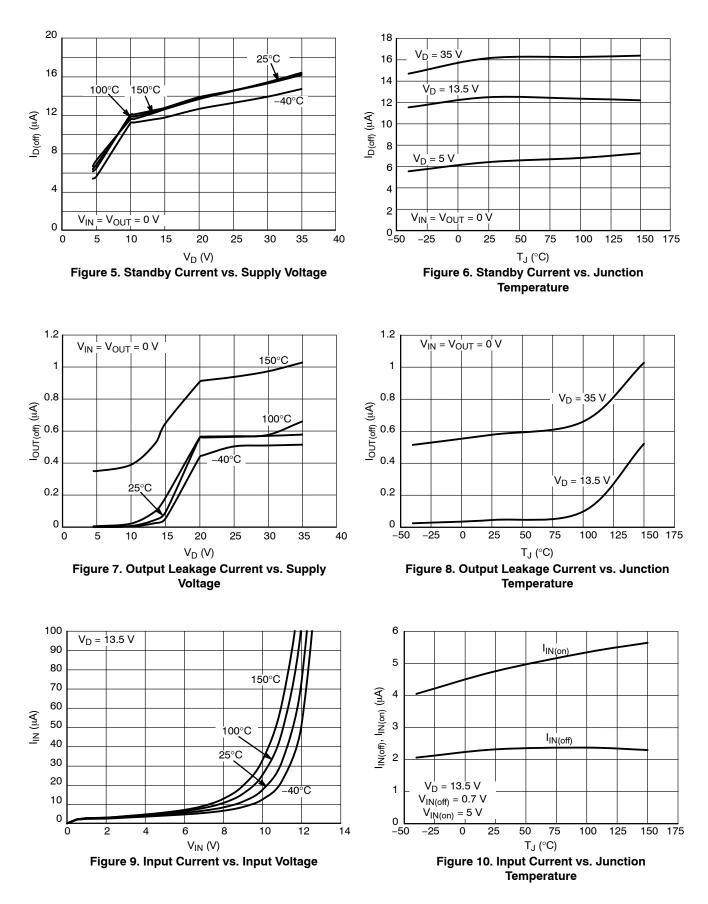
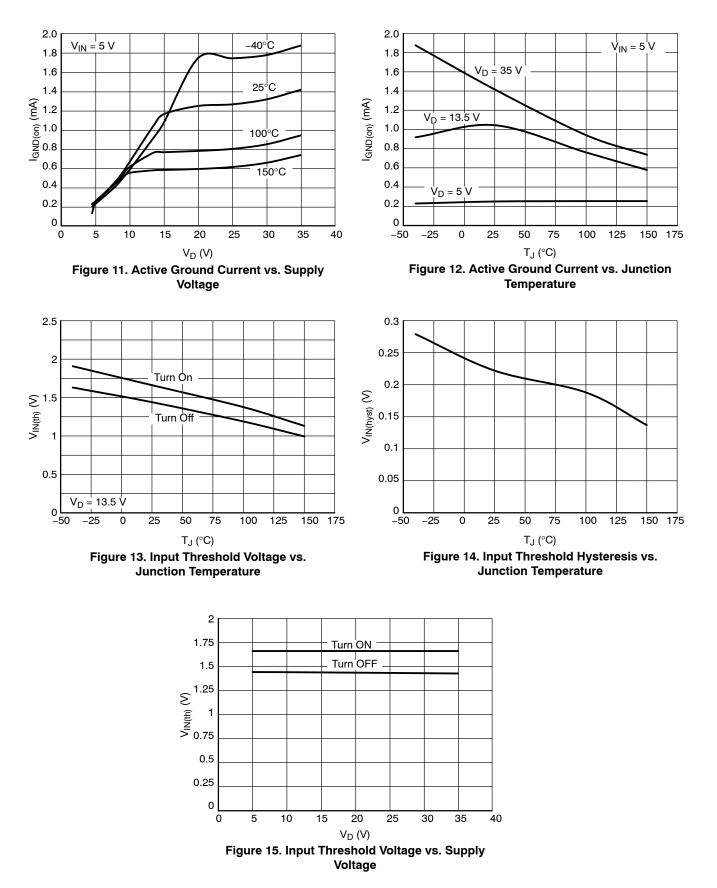


Figure 4. Resistive Load Switching Waveform

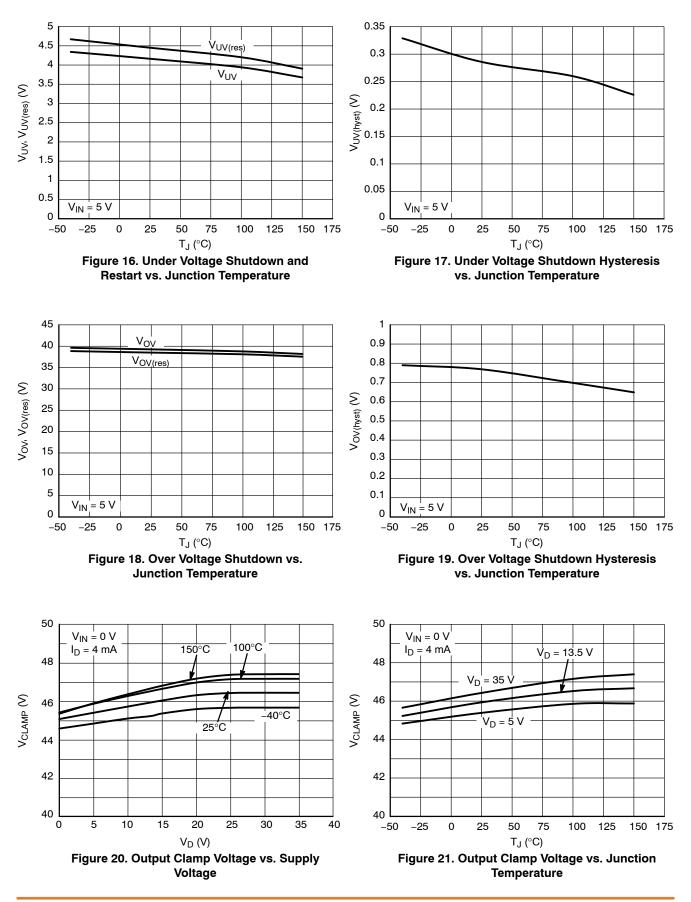




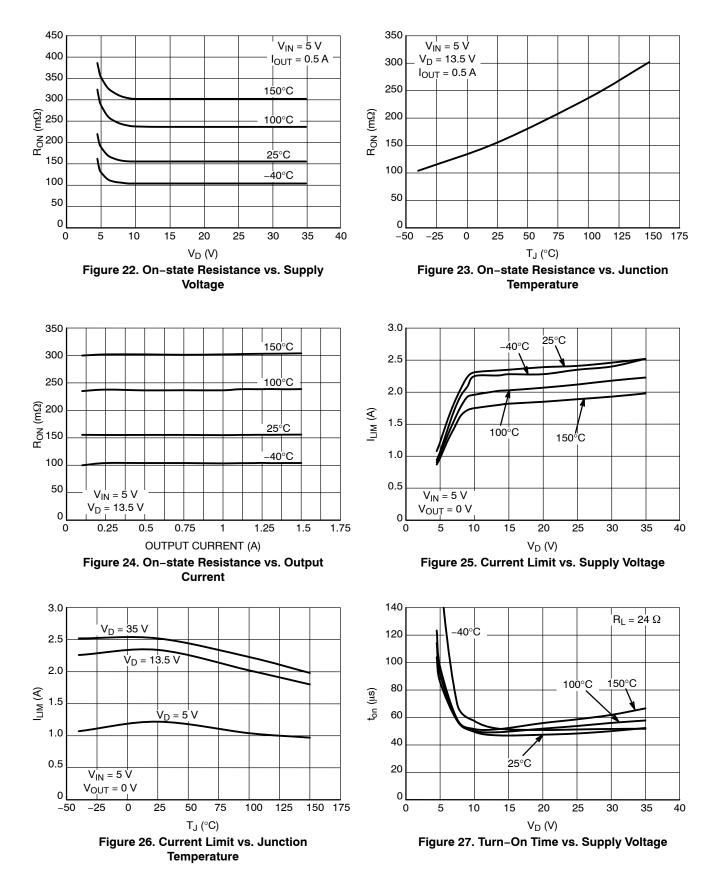




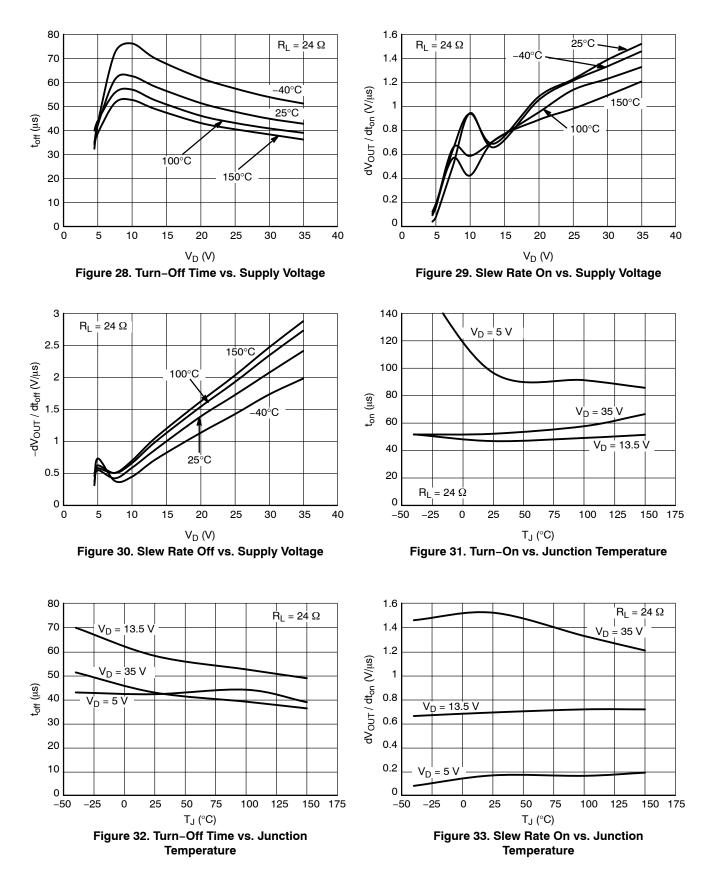






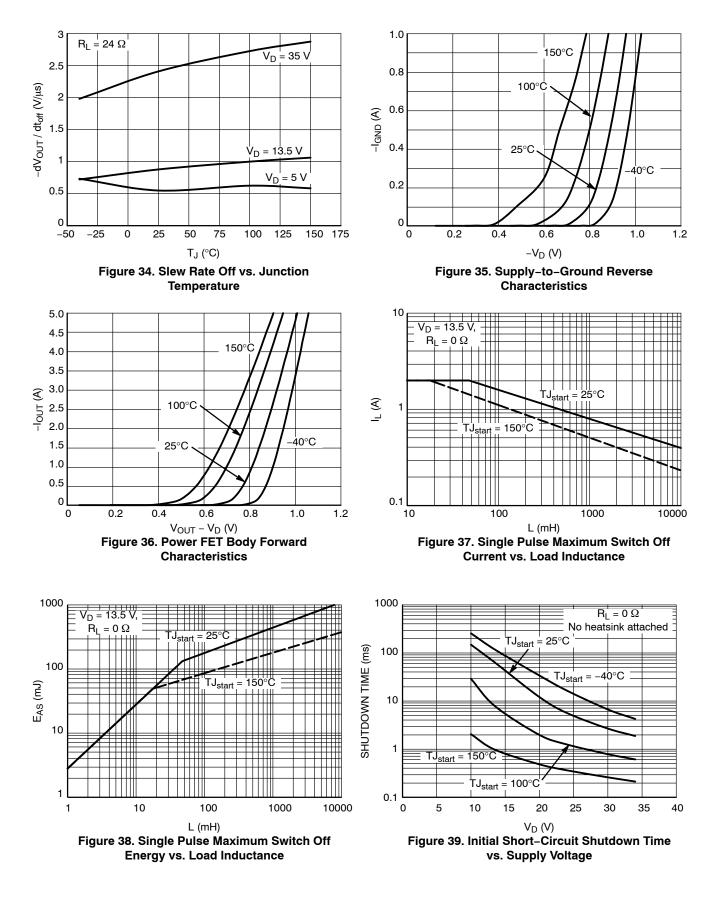




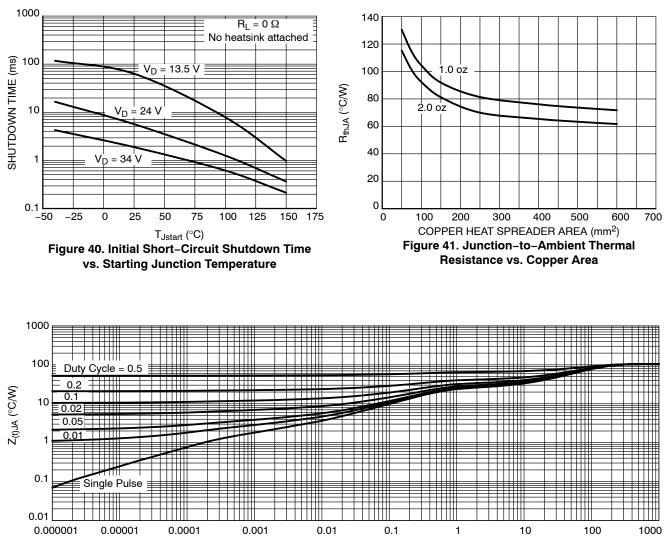




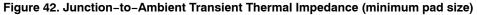








PULSE TIME (sec)



ORDERING INFORMATION

Device	Package	Shipping [†]
NCV8452STT1G	SOT-223 (Pb-Free)	1000 / Tape & Reel
NCV8452STT3G	SOT-223 (Pb-Free)	4000 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.



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SOT-223 (TO-261) CASE 318E-04 ISSUE R

SEE DETAIL A

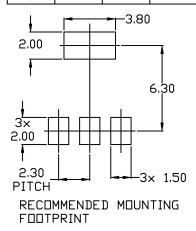
FRONT VIEW

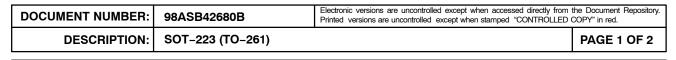
DATE 02 OCT 2018



- 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
- 2. CONTROLLING DIMENSION: MILLIMETERS
- 3. DIMENSIONS D & E DO NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH, PROTRUSIONS OR GATE BURRS SHALL NOT EXCEED 0.200MM PER SIDE.
- 4. DATUMS A AND B ARE DETERMINED AT DATUM H.
- AI IS DEFINED AS THE VERTICAL DISTANCE FROM THE SEATING PLANE TO THE LOWEST POINT OF THE PACKAGE BODY.
- 6. POSITIONAL TOLERANCE APPLIES TO DIMENSIONS & AND &1.

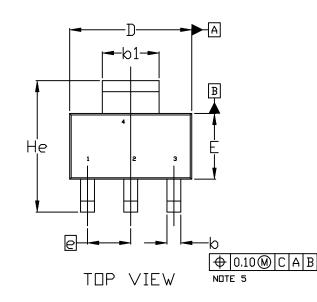
	MILLIMETERS			
DIM	MIN.	NDM.	MAX.	
A	1.50	1.63	1.75	
A1	0.02	0.06	0.10	
b	0.60	0.75	0.89	
b1	2.90	3.06	3.20	
с	0.24	0.29	0.35	
D	6.30	6.50	6.70	
E	3.30	3.50	3.70	
e	2.30 BSC			
L	0.20			
L1	1.50	1.75	2.00	
He	6.70	7.00	7.30	
θ	0*		10 °	

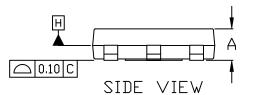


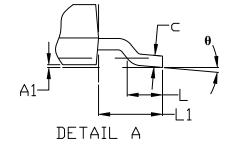


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SCALE 1:1







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SOT-223 (TO-261) CASE 318E-04 **ISSUE R**

DATE 02 OCT 2018

STYLE 1: PIN 1. BASE 2. COLLECTOR 3. EMITTER 4. COLLECTOR	STYLE 2: PIN 1. ANODE 2. CATHODE 3. NC 4. CATHODE	STYLE 3: PIN 1. GATE 2. DRAIN 3. SOURCE 4. DRAIN	STYLE 4: Pin 1. Source 2. Drain 3. Gate 4. Drain	STYLE 5: PIN 1. DRAIN 2. GATE 3. SOURCE 4. GATE
STYLE 6: PIN 1. RETURN 2. INPUT 3. OUTPUT 4. INPUT	STYLE 7: PIN 1. ANODE 1 2. CATHODE 3. ANODE 2 4. CATHODE	STYLE 8: CANCELLED	STYLE 9: Pin 1. Input 2. Ground 3. Logic 4. Ground	STYLE 10: PIN 1. CATHODE 2. ANODE 3. GATE 4. ANODE
STYLE 11: PIN 1. MT 1 2. MT 2 3. GATE 4. MT 2	Style 12: Pin 1. Input 2. Output 3. NC 4. Output	STYLE 13: PIN 1. GATE 2. COLLECTOR 3. EMITTER 4. COLLECTOR		

GENERIC **MARKING DIAGRAM***



- = Assembly Location А
- Y = Year
- W = Work Week
- XXXXX = Specific Device Code .
- = Pb-Free Package
- (Note: Microdot may be in either location) *This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

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DESCRIPTION:	SOT-223 (TO-261)		PAGE 2 OF 2	

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